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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Panasonic

DRA3124X0L

Silicon PNP epitaxial planar type

For digital circuits
Complementary to DRC3124X
DRA9124X in SSSMini3 type package

■ Features

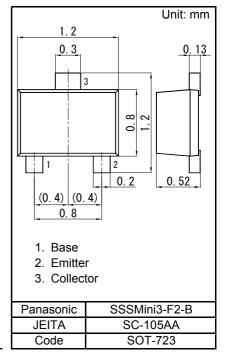
- · High forward current transfer ratio Hfe
- · Low collector-emitter saturation voltage Vce(sat)
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: LF

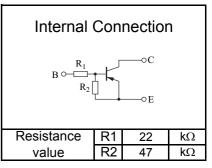
■ Packaging

Embossed type (Thermo-compression sealing): 10 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

| Parameter | Symbol | Rating | Unit |
|---------------------------------------|--------|-------------|------|
| Collector-base voltage (Emitter open) | VCBO | -50 | V |
| Collector-emitter voltage (Base open) | VCEO | -50 | V |
| Collector current | IC | -100 | mA |
| Total power dissipation | PT | 100 | mW |
| Junction temperature | Tj | 150 | °C |
| Operating ambient temperature | Topr | -40 to +85 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |





■ Electrical Characteristics Ta = 25 °C ± 3 °C

Established: 2009-10-23

: 2014-02-19

Revised

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--|----------|---------------------------|------|------|-------|------|
| Collector-base voltage (Emitter open) | VCBO | IC = -10 μA, IE = 0 | -50 | | | V |
| Collector-emitter voltage (Base open) | VCEO | IC = -2 mA, IB = 0 | -50 | | | V |
| Collector-base cutoff current (Emitter open) | ICBO | VCB = -50 V, IE = 0 | | | -0.1 | μΑ |
| Collector-emitter cutoff current (Base open) | ICEO | VCE = -50 V, IB = 0 | | | -0.5 | μΑ |
| Emitter-base cutoff current (Collector open) | IEBO | VEB = -6 V, IC = 0 | | | -0.2 | mA |
| Forward current transfer ratio | hFE | VCE = -10 V, IC = -5 mA | 80 | | 400 | - |
| Collector-emitter saturation voltage | VCE(sat) | IC = -10 mA, IB = -0.5 mA | | | -0.25 | V |
| Input voltage | Vi(on) | VCE = -0.2 V, IC = -5 mA | -2.1 | | | V |
| | Vi(off) | VCE = -5 V, IC = -100 μA | | | -0.6 | V |
| Input resistance | R1 | | -30% | 22 | +30% | kΩ |
| Resistance ratio | R1/R2 | | 0.37 | 0.47 | 0.57 | - |

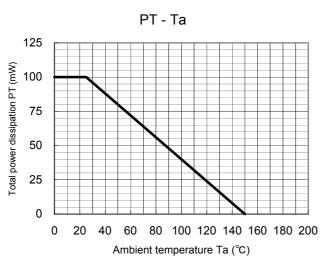
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

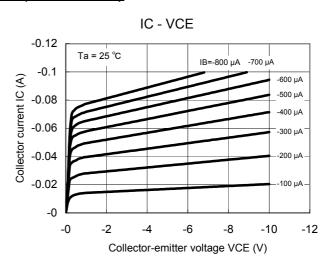
Transistors with Built-in Resistor

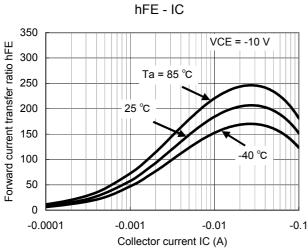
DRA3124X0L

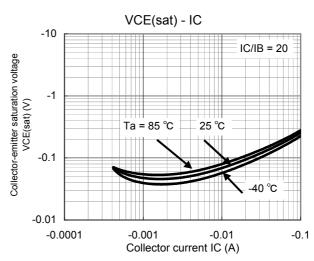
Panasonic

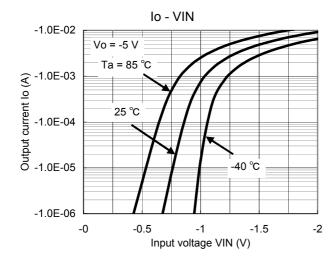
Technical Data (reference)

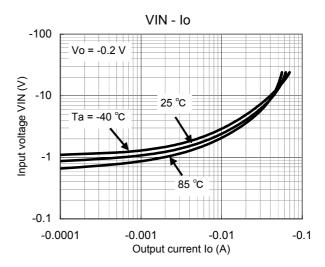












Page 2 of 3

Established: 2009-10-23 Revised: 2014-02-19

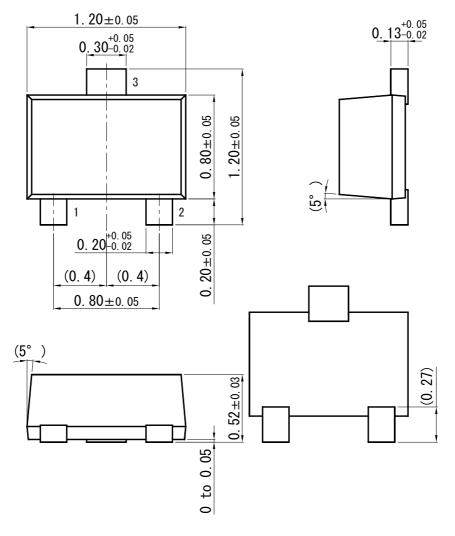
Transistors with Built-in Resistor

DRA3124X0L

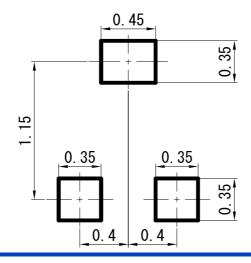
SSSMini3-F2-B

Panasonic

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



Page 3 of 3

Established: 2009-10-23 Revised: 2014-02-19

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